



In re application of:

Yasuo Okada

Serial No: 10/619,934

Filed: July 15, 2003

For: MANUFACTURING METHOD OF SEMICONDUCTOR  
DEVICE AND SEMICONDUCTOR DEVICE

Art Unit: 2823

Confirmation No.: 6832

Examiner: Hsien-Ming Lee

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents P.O. Box 1450, Alexandria, VA 22313-1450, on

June 14, 2004

Date of Deposit

William H. Wright, Reg. No. 36,312

Name

Signature

6/14/04

Date

Mail Stop Non-Fee Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an amendment in the above-identified application.

☒ Annotated Sheets of Drawings Showing changes to FIGS. 1-3 and replacement sheets enclosed.☒ No additional fee is required.

The fee has been calculated as shown below:

	(Col. 1) CLAIMS REMAINING AFTER AMENDMENT		(Col. 2) HIGHEST NUMBER PREVIOUSLY PAID FOR	(Col. 3) PRESENT EXTRA*	LG/SM \$ ENTITY FEE		ADD'L FEE DUE
TOTAL CLAIMS FEE	16	-	20**	0	LG=\$18 SM=\$9	\$18	\$ 0
INDEPENDENT CLAIMS FEE	3	-	3***	0	LG=\$86 SM=\$43	\$86	\$ 0
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIMS					LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145		\$
TOTAL							\$ 0

\* If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

\*\* If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.

\*\*\* If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest Number Previously Paid For" (Total or Independent) is the highest number found from the equivalent box on Col. 1 of a prior amendment or the number of claims originally filed.

☐ A check in the amount of \$ 0 to cover the additional claims fee is enclosed. **A copy of this sheet is enclosed.**☐ A check in the amount of \$ 0 to cover the extension fee is enclosed. **A copy of this sheet is enclosed.**☒ The Commissioner is hereby authorized to charge any deficiencies of fees associated with this communication or credit any overpayment to Deposit Account No. 50-1314. **A copy of this sheet is enclosed.**☒ Any filing fees under 37 C.F.R. § 1.16 for the presentation of extra claims☒ Any patent application processing fees under 37 C.F.R. § 1.17Respectfully submitted,  
HOGAN & HARTSON L.L.P.By: William H. Wright  
Registration No. 36,312  
Attorney for Applicant(s)

Date: June 14, 2004

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Appl. No. 10/619,934  
Amdt. Dated June 14, 2004  
Reply to Office Action of March 22, 2004

Attorney Docket No. 81788.0253  
Customer No.: 26021



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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6/14/04

Date

**AMENDMENT**

Mail Stop No Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated March 22, 2004, please amend the  
above-referenced application as follows:

**Amendments** to the Claims are reflected in the listing of claims which begins on  
page 2 of this paper.

**Amendments** to the Drawings begin on page 6 of this paper and include both an  
attached replacement sheet and an annotated sheet showing changes.

**Remarks/Arguments** begin on page 7 of this paper.

An **Appendix** including amended drawing figures is attached following the last  
page of this paper.